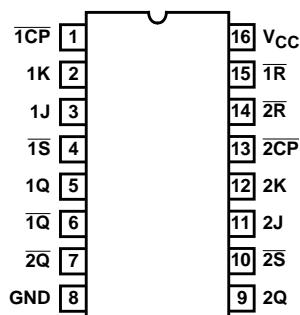


## Features

- Hysteresis on Clock Inputs for Improved Noise Immunity and Increased Input Rise and Fall Times
- Asynchronous Set and Reset
- Complementary Outputs
- Buffered Inputs
- Typical  $f_{MAX} = 60\text{MHz}$  at  $V_{CC} = 5\text{V}$ ,  $C_L = 15\text{pF}$ ,  $T_A = 25^\circ\text{C}$
- Fanout (Over Temperature Range)
  - Standard Outputs ..... 10 LSTTL Loads
  - Bus Driver Outputs ..... 15 LSTTL Loads
- Wide Operating Temperature Range ...  $-55^\circ\text{C}$  to  $125^\circ\text{C}$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5\text{V}$
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8\text{V}$  (Max),  $V_{IH} = 2\text{V}$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu\text{A}$  at  $V_{OL}, V_{OH}$

## Pinout

CD54HC112, CD54HCT112 (CERDIP)  
 CD74HC112 (PDIP, SOIC, SOP, TSSOP)  
 CD74HCT112 (PDIP)  
 TOP VIEW



## Description

The 'HC112 and 'HCT112 utilize silicon-gate CMOS technology to achieve operating speeds equivalent to LSTTL parts. They exhibit the low power consumption of standard CMOS integrated circuits, together with the ability to drive 10 LSTTL loads.

These flip-flops have independent J, K, Set, Reset, and Clock inputs and Q and  $\bar{Q}$  outputs. They change state on the negative-going transition of the clock pulse. Set and Reset are accomplished asynchronously by low-level inputs.

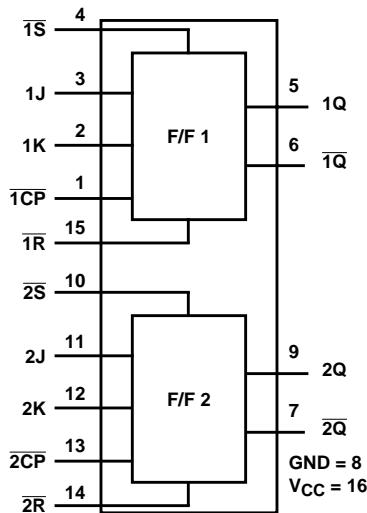
The HCT logic family is functionally as well as pin-compatible with the standard LS logic family.

## Ordering Information

| PART NUMBER   | TEMP. RANGE<br>(°C) | PACKAGE      |
|---------------|---------------------|--------------|
| CD54HC112F3A  | -55 to 125          | 16 Ld CERDIP |
| CD54HCT112F3A | -55 to 125          | 16 Ld CERDIP |
| CD74HC112E    | -55 to 125          | 16 Ld PDIP   |
| CD74HC112MT   | -55 to 125          | 16 Ld SOIC   |
| CD74HC112M96  | -55 to 125          | 16 Ld SOIC   |
| CD74HC112NSR  | -55 to 125          | 16 Ld SOP    |
| CD74HC112PW   | -55 to 125          | 16 Ld TSSOP  |
| CD74HC112PWR  | -55 to 125          | 16 Ld TSSOP  |
| CD74HC112PWT  | -55 to 125          | 16 Ld TSSOP  |
| CD74HCT112E   | -55 to 125          | 16 Ld PDIP   |

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

**Functional Diagram**



**TRUTH TABLE**

| INPUTS    |           |            |   |   | OUTPUTS    |            |
|-----------|-----------|------------|---|---|------------|------------|
| $\bar{S}$ | $\bar{R}$ | $\bar{CP}$ | J | K | Q          | $\bar{Q}$  |
| L         | H         | X          | X | X | H          | L          |
| H         | L         | X          | X | X | L          | H          |
| L         | L         | X          | X | X | H (Note 1) | H (Note 1) |
| H         | H         | ↓          | L | L | No Change  |            |
| H         | H         | ↓          | H | L | H          | L          |
| H         | H         | ↓          | L | H | L          | H          |
| H         | H         | ↓          | H | H | Toggle     |            |
| H         | H         | H          | X | X | No Change  |            |

H= High Level (Steady State)

L= Low Level (Steady State)

X= Don't Care

↓= High-to-Low Transition

NOTE:

1. Output states unpredictable if both  $\bar{S}$  and  $\bar{R}$  go High simultaneously after both being low at the same time.

# CD54HC112, CD74HC112, CD54HCT112, CD74HCT112

## Absolute Maximum Ratings

|   |       |             |
|---|-------|-------------|
| DC Supply Voltage, V <sub>CC</sub>                                    | ..... | -0.5V to 7V |
| DC Input Diode Current, I <sub>IK</sub>                               |       |             |
| For V <sub>I</sub> < -0.5V or V <sub>I</sub> > V <sub>CC</sub> + 0.5V | ..... | ±20mA       |
| DC Drain Current, per Output, I <sub>O</sub>                          |       |             |
| For -0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V                   | ..... | ±25mA       |
| DC Output Diode Current, I <sub>OK</sub>                              |       |             |
| For V <sub>O</sub> < -0.5V or V <sub>O</sub> > V <sub>CC</sub> + 0.5V | ..... | ±20mA       |
| DC Output Source or Sink Current per Output Pin, I <sub>O</sub>       |       |             |
| For V <sub>O</sub> > -0.5V or V <sub>O</sub> < V <sub>CC</sub> + 0.5V | ..... | ±25mA       |
| DC V <sub>CC</sub> or Ground Current, I <sub>CC</sub>                 | ..... | ±50mA       |

## Thermal Information

|  |                      |
|--|----------------------|
| Package Thermal Impedance, θ <sub>JA</sub> (see Note 2): |                      |
| E (PDIP) Package   | ..... 67°C/W         |
| NS (SOP) Package   | ..... 64°C/W         |
| D (SOIC) Package   | ..... 73°C/W         |
| PW (TSSOP) Package                                       | ..... 108°C/W        |
| Maximum Junction Temperature (Hermetic Package or Die)   | ..... 175°C          |
| Maximum Junction Temperature (Plastic Package)           | ..... 150°C          |
| Maximum Storage Temperature Range                        | ..... -65°C to 150°C |
| Maximum Lead Temperature (Soldering 10s)                 | ..... 300°C          |

## Operating Conditions

|   |       |                       |
|---|-------|-----------------------|
| Temperature Range, T <sub>A</sub>                           | ..... | -55°C to 125°C        |
| Supply Voltage Range, V <sub>CC</sub>                       |       |                       |
| HC Types  | ..... | .2V to 6V             |
| HCT Types   | ..... | .45V to 5.5V          |
| DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> | ..... | 0V to V <sub>CC</sub> |
| Input Rise and Fall Time, t <sub>r</sub> , t <sub>f</sub>   |       |                       |
| 2V  | ..... | 1.0ms (Max)           |
| 4.5V  | ..... | 1.0ms (Max)           |
| 6V  | ..... | 1.0ms (Max)           |

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

- The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

| PARAMETER                            | SYMBOL          | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |      |      | -40°C TO 85°C |      | -55°C TO 125°C |      | UNITS |   |
|--------------------------------------|-----------------|------------------------------------|---------------------|---------------------|------|------|------|---------------|------|----------------|------|-------|---|
|                                      |                 | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP  | MAX  | MIN           | MAX  | MIN            | MAX  |       |   |
| <b>HC TYPES</b>                      |                 |                                    |                     |                     |      |      |      |               |      |                |      |       |   |
| High Level Input Voltage             | V <sub>IH</sub> | -                                  | -                   | 2                   | 1.5  | -    | -    | 1.5           | -    | 1.5            | -    | V     |   |
|                                      |                 |                                    |                     | 4.5                 | 3.15 | -    | -    | 3.15          | -    | 3.15           | -    | V     |   |
|                                      |                 |                                    |                     | 6                   | 4.2  | -    | -    | 4.2           | -    | 4.2            | -    | V     |   |
| Low Level Input Voltage              | V <sub>IL</sub> | -                                  | -                   | 2                   | -    | -    | 0.5  | -             | 0.5  | -              | 0.5  | V     |   |
|                                      |                 |                                    |                     | 4.5                 | -    | -    | 1.35 | -             | 1.35 | -              | 1.35 | V     |   |
|                                      |                 |                                    |                     | 6                   | -    | -    | 1.8  | -             | 1.8  | -              | 1.8  | V     |   |
| High Level Output Voltage CMOS Loads | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 2                   | 1.9  | -    | -    | 1.9           | -    | 1.9            | -    | V     |   |
|                                      |                 |                                    |                     | 4.5                 | 4.4  | -    | -    | 4.4           | -    | 4.4            | -    | V     |   |
|                                      |                 |                                    |                     | 6                   | 5.9  | -    | -    | 5.9           | -    | 5.9            | -    | V     |   |
| High Level Output Voltage TTL Loads  |                 |                                    | -4                  | -                   | -    | -    | -    | -             | -    | -              | -    | V     |   |
|                                      |                 |                                    |                     | -4                  | 4.5  | 3.98 | -    | -             | 3.84 | -              | 3.7  | -     | V |
|                                      |                 |                                    |                     | -5.2                | 6    | 5.48 | -    | -             | 5.34 | -              | 5.2  | -     | V |
| Low Level Output Voltage CMOS Loads  | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2                   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |   |
|                                      |                 |                                    |                     | 4.5                 | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |   |
|                                      |                 |                                    |                     | 6                   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |   |
| Low Level Output Voltage TTL Loads   |                 |                                    | -                   | -                   | -    | -    | -    | -             | -    | -              | -    | V     |   |
|                                      |                 |                                    |                     | 4                   | 4.5  | -    | -    | 0.26          | -    | 0.33           | -    | 0.4   | V |
|                                      |                 |                                    |                     | 5.2                 | 6    | -    | -    | 0.26          | -    | 0.33           | -    | 0.4   | V |
| Input Leakage Current                | I <sub>I</sub>  | V <sub>CC</sub> or GND             | -                   | 6                   | -    | -    | ±0.1 | -             | ±1   | -              | ±1   | µA    |   |

# CD54HC112, CD74HC112, CD54HCT112, CD74HCT112

## DC Electrical Specifications (Continued)

| PARAMETER  | SYMBOL                    | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |     |      | -40°C TO 85°C |      | -55°C TO 125°C |     | UNITS |
|--|---------------------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|-----|-------|
|  |                           | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX |       |
| Quiescent Device Current                                       | I <sub>CC</sub>           | V <sub>CC</sub> or GND             | 0                   | 6                   | -    | -   | 4    | -             | 40   | -              | 80  | µA    |
| <b>HCT TYPES</b>   |                           |                                    |                     |                     |      |     |      |               |      |                |     |       |
| High Level Input Voltage                                       | V <sub>IH</sub>           | -                                  | -                   | 4.5 to 5.5          | 2    | -   | -    | 2             | -    | 2              | -   | V     |
| Low Level Input Voltage  | V <sub>IL</sub>           | -                                  | -                   | 4.5 to 5.5          | -    | -   | 0.8  | -             | 0.8  | -              | 0.8 | V     |
| High Level Output Voltage CMOS Loads                           | V <sub>OH</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -   | V     |
| High Level Output Voltage TTL Loads                            |                           |                                    | -4                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -   | V     |
| Low Level Output Voltage CMOS Loads                            | V <sub>OL</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1 | V     |
| Low Level Output Voltage TTL Loads                             |                           |                                    | 4                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4 | V     |
| Input Leakage Current  | I <sub>I</sub>            | V <sub>CC</sub> and GND            | -                   | 5.5                 | -    |     | ±0.1 | -             | ±1   | -              | ±1  | µA    |
| Quiescent Device Current                                       | I <sub>CC</sub>           | V <sub>CC</sub> or GND             | 0                   | 5.5                 | -    | -   | 4    | -             | 40   | -              | 80  | µA    |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI <sub>CC</sub> (Note 3) | V <sub>CC</sub> - 2.1              | -                   | 4.5 to 5.5          | -    | 100 | 360  | -             | 450  | -              | 490 | µA    |

NOTE:

- For dual-supply systems theoretical worst case (V<sub>I</sub> = 2.4V, V<sub>CC</sub> = 5.5V) specification is 1.8mA.

## HCT Input Loading Table

| INPUT            | UNIT LOADS |
|------------------|------------|
| 1S, 2S           | 0.5        |
| 1K, 2K           | 0.6        |
| 1R, 2R           | 0.65       |
| 1J, 2J, 1CP, 2CP | 1          |

NOTE: Unit Load is ΔI<sub>CC</sub> limit specified in DC Electrical Specifications table, e.g., 360µA max at 25°C.

## Prerequisite For Switching Specifications

| PARAMETER       | SYMBOL         | TEST CONDITIONS | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|-----------------|----------------|-----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                 |                |                 |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| <b>HC TYPES</b> |                |                 |                     |      |     |     |               |     |                |     |       |
| Pulse Width CP  | t <sub>W</sub> | -               | 2                   | 80   | -   | -   | 100           | -   | 120            | -   | ns    |
|                 |                |                 | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   | ns    |
|                 |                |                 | 6                   | 14   | -   | -   | 17            | -   | 20             | -   | ns    |

# CD54HC112, CD74HC112, CD54HCT112, CD74HCT112

## Prerequisite For Switching Specifications (Continued)

| PARAMETER  | SYMBOL    | TEST CONDITIONS | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     |
|--|-----------|-----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|
|  |           |                 |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |
| Pulse Width $\bar{R}$ , $\bar{S}$                              | $t_W$     | -               | 2                   | 80   | -   | -   | 100           | -   | 120            | -   |
|  |           |                 | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   |
|  |           |                 | 6                   | 14   | -   | -   | 17            | -   | 20             | -   |
| Setup Time J, K, to $\bar{CP}$                                 | $t_{SU}$  | -               | 2                   | 80   | -   | -   | 100           | -   | 120            | -   |
|  |           |                 | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   |
|  |           |                 | 6                   | 14   | -   | -   | 17            | -   | 20             | -   |
| Hold Time J, K, to $\bar{CP}$                                  | $t_H$     | -               | 2                   | 0    | -   | -   | 0             | -   | 0              | -   |
|  |           |                 | 4.5                 | 0    | -   | -   | 0             | -   | 0              | -   |
|  |           |                 | 6                   | 0    | -   | -   | 0             | -   | 0              | -   |
| Removal Time $\bar{R}$ to $\bar{CP}$ , $\bar{S}$ to $\bar{CP}$ | $t_{REM}$ | -               | 2                   | 80   | -   | -   | 100           | -   | 120            | -   |
|  |           |                 | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   |
|  |           |                 | 6                   | 14   | -   | -   | 17            | -   | 20             | -   |
| CP Frequency   | $f_{MAX}$ | -               | 2                   | 6    | -   | -   | 5             | -   | 4              | -   |
|  |           |                 | 4.5                 | 30   | -   | -   | 25            | -   | 20             | -   |
|  |           |                 | 6                   | 35   | -   | -   | 29            | -   | 23             | -   |
| <b>HCT TYPES</b>   |           |                 |                     |      |     |     |               |     |                |     |
| Pulse Width $\bar{CP}$   | $t_{SU}$  | -               | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   |
| Pulse Width $\bar{R}$ , $\bar{S}$                              | $t_W$     | -               | 4.5                 | 18   | -   | -   | 23            | -   | 27             | -   |
| Setup Time J, K, to $\bar{CP}$                                 | $t_H$     | -               | 4.5                 | 16   | -   | -   | 20            | -   | 24             | -   |
| Hold Time J, K, to $\bar{CP}$                                  | $t_{REM}$ | -               | 4.5                 | 3    | -   | -   | 3             | -   | 3              | -   |
| Removal Time $\bar{R}$ to $\bar{CP}$ , $\bar{S}$ to $\bar{CP}$ | $t_W$     | -               | 4.5                 | 20   | -   | -   | 25            | -   | 30             | -   |
| CP Frequency   | $f_{MAX}$ | -               | 4.5                 | 30   | -   | -   | 25            | -   | 20             | -   |

**Switching Specifications** Input  $t_r$ ,  $t_f = 6\text{ns}$

| PARAMETER                                     | SYMBOL             | TEST CONDITIONS     | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     |
|---|--------------------|---------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|
|   |                    |                     |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |
| <b>HC TYPES</b>                               |                    |                     |                     |      |     |     |               |     |                |     |
| Propagation Delay, $\bar{CP}$ to Q, $\bar{Q}$ | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 2                   | -    | -   | 175 | -             | 220 | -              | 265 |
|   |                    |                     | 4.5                 | -    | -   | 35  | -             | 44  | -              | 53  |
|   |                    |                     | 5                   | -    | 14  | -   | -             | -   | -              | -   |
|   |                    |                     | 6                   | -    | -   | 30  | -             | 37  | -              | 45  |
| Propagation Delay, $\bar{S}$ to Q, $\bar{Q}$  | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 2                   | -    | -   | 155 | -             | 195 | -              | 235 |
|   |                    |                     | 4.5                 | -    | -   | 31  | -             | 39  | -              | 47  |
|   |                    |                     | 5                   | -    | 13  | -   | -             | -   | -              | -   |
|   |                    |                     | 6                   | -    | -   | 26  | -             | 33  | -              | 40  |
| Propagation Delay, $\bar{R}$ to Q, $\bar{Q}$  | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 2                   | -    | -   | 180 | -             | 225 | -              | 270 |
|   |                    |                     | 4.5                 | -    | -   | 36  | -             | 45  | -              | 54  |
|   |                    |                     | 5                   | -    | 15  | -   | -             | -   | -              | -   |
|   |                    |                     | 6                   | -    | -   | 31  | -             | 38  | -              | 46  |

# CD54HC112, CD74HC112, CD54HCT112, CD74HCT112

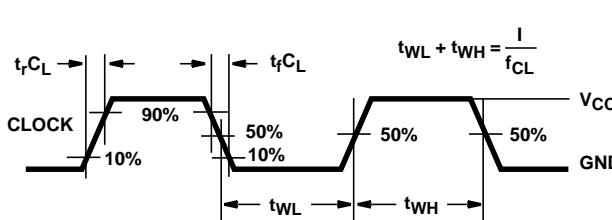
## Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

| PARAMETER                                     | SYMBOL             | TEST CONDITIONS     | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|---|--------------------|---------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|   |                    |                     |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| Output Transition Time                        | $t_{TLH}, t_{THL}$ | $C_L = 50\text{pF}$ | 2                   | -    | -   | 75  | -             | 95  | -              | 110 | ns    |
|   |                    | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 15  | -             | 19  | -              | 22  | ns    |
|   |                    | $C_L = 50\text{pF}$ | 6                   | -    | -   | 13  | -             | 16  | -              | 19  | ns    |
| Input Capacitance                             | $C_I$              | -                   | -                   | -    | -   | 10  | -             | 10  | -              | 10  | pF    |
| CP Frequency                                  | $f_{MAX}$          | $C_L = 15\text{pF}$ | 5                   | -    | 60  | -   | -             | -   | -              | -   | MHz   |
| Power Dissipation Capacitance (Notes 4, 5)    | $C_{PD}$           | -                   | 5                   | -    | 12  | -   | -             | -   | -              | -   | pF    |
| <b>HCT TYPES</b>                              |                    |                     |                     |      |     |     |               |     |                |     |       |
| Propagation Delay, $\bar{C}P$ to $Q, \bar{Q}$ | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 35  | -             | 44  | -              | 53  | ns    |
|   |                    | $C_L = 15\text{pF}$ | 5                   | -    | 14  | -   | -             | -   | -              | -   | ns    |
| Propagation Delay, $\bar{S}$ to $Q, \bar{Q}$  | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 32  | -             | 40  | -              | 48  | ns    |
|   |                    | $C_L = 15\text{pF}$ | 5                   | -    | 13  | -   | -             | -   | -              | -   | ns    |
| Propagation Delay, $R$ to $Q, \bar{Q}$        | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 37  | -             | 46  | -              | 56  | ns    |
|   |                    | $C_L = 15\text{pF}$ | 5                   | -    | 14  | -   | -             | -   | -              | -   | ns    |
| Output Transition Time                        | $t_{TLH}, t_{THL}$ | $C_L = 50\text{pF}$ | 4.5                 | -    | -   | 15  | -             | 19  | -              | 22  | ns    |
| Input Capacitance                             | $C_I$              | -                   | -                   | -    | -   | 10  | -             | 10  | -              | 10  | pF    |
| CP Frequency                                  | $f_{MAX}$          | $C_L = 15\text{pF}$ | 5                   | -    | 60  | -   | -             | -   | -              | -   | MHz   |
| Power Dissipation Capacitance (Notes 4, 5)    | $C_{PD}$           | -                   | 5                   | -    | 20  | -   | -             | -   | -              | -   | pF    |

### NOTES:

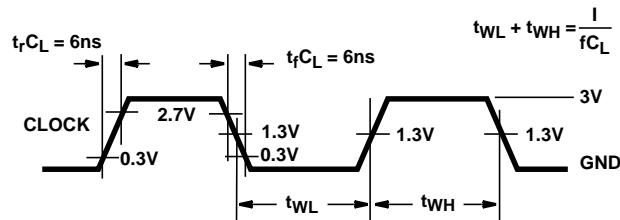
4.  $C_{PD}$  is used to determine the dynamic power consumption, per flip-flop.
5.  $P_D = C_{PD} V_{CC}^2 f_i + \sum C_L f_0$  where  $f_i$  = input frequency,  $f_0$  = output frequency,  $C_L$  = output load capacitance,  $V_{CC}$  = supply voltage.

## Test Circuits and Waveforms



NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

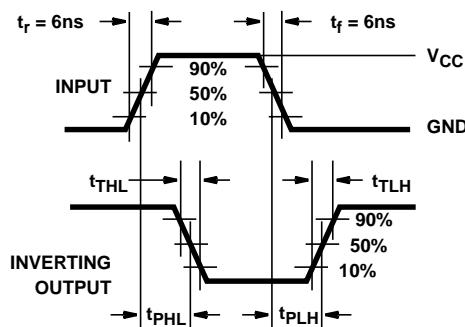
**FIGURE 1. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**



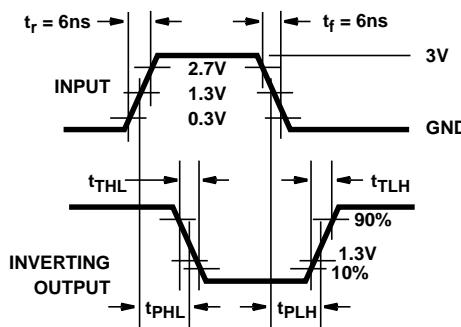
NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

**FIGURE 2. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**

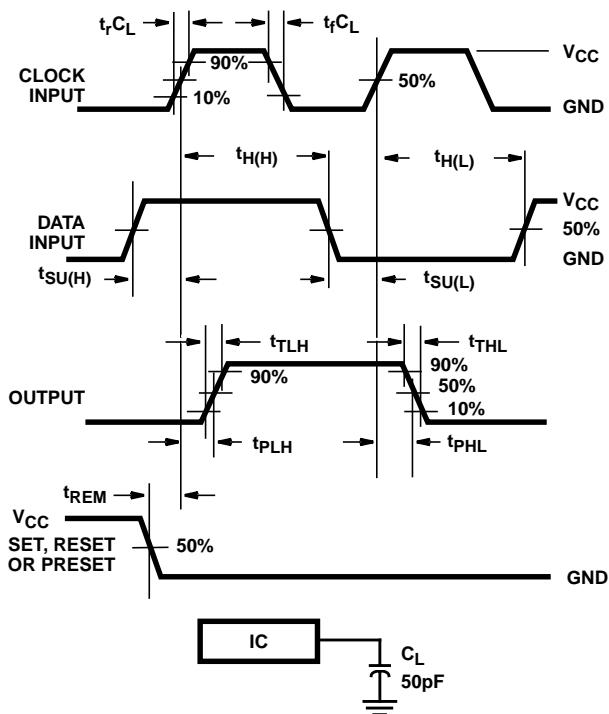
**Test Circuits and Waveforms (Continued)**



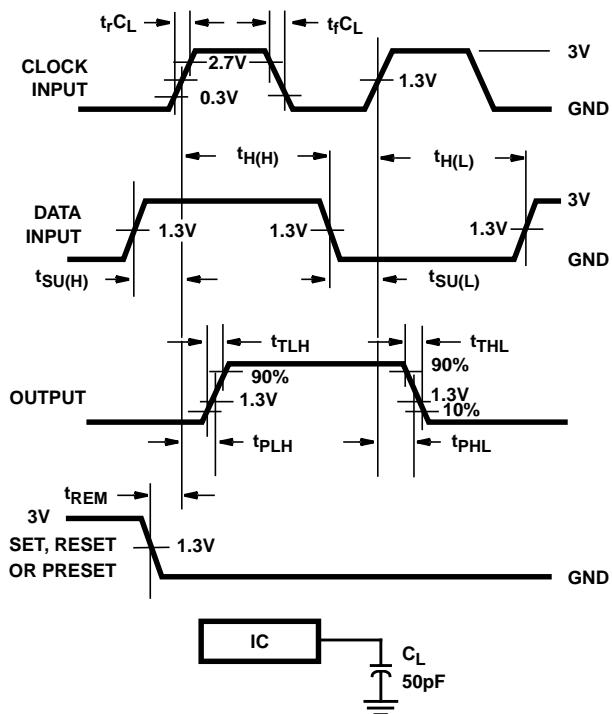
**FIGURE 3. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



**FIGURE 4. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



**FIGURE 5. HC SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**

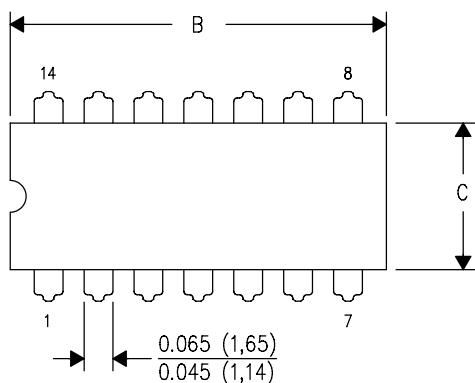


**FIGURE 6. HCT SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**

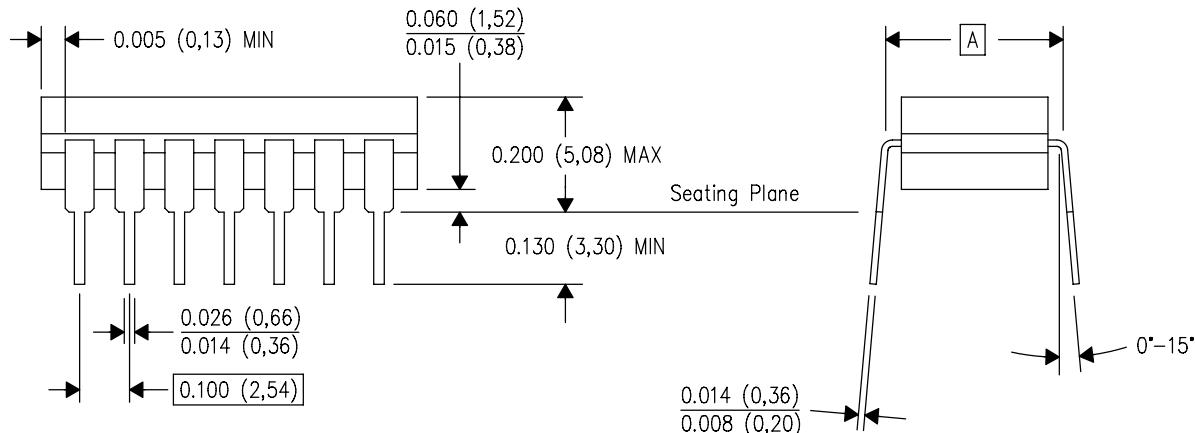
J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| PINS **\nDIM | 14                     | 16                     | 18                     | 20                     |
|--------------|------------------------|------------------------|------------------------|------------------------|
| A            | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX        | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN        | —                      | —                      | —                      | —                      |
| C MAX        | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN        | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

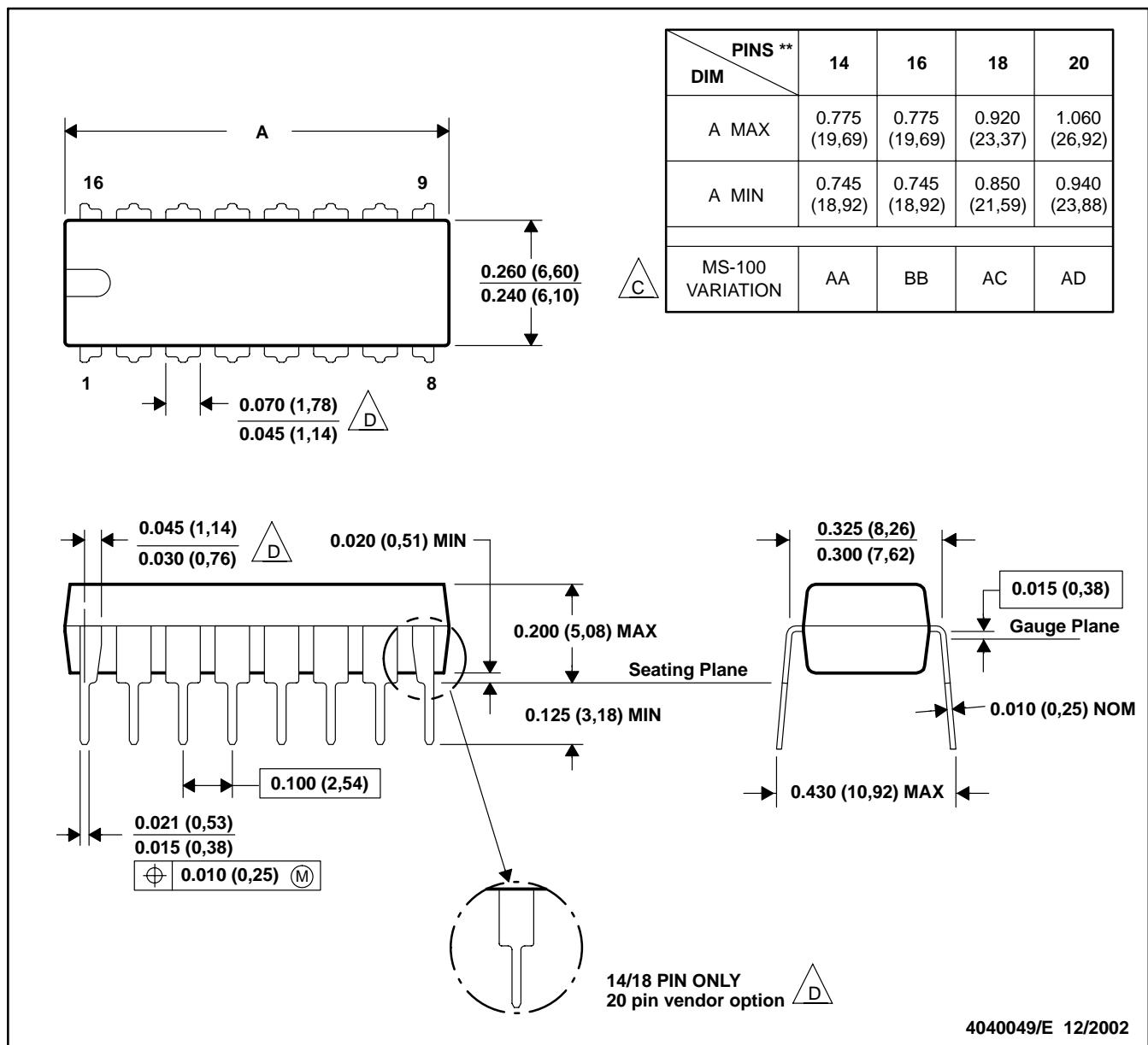
# MECHANICAL

MPDI002C – JANUARY 1995 – REVISED DECEMBER 20002

N (R-PDIP-T\*\*)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

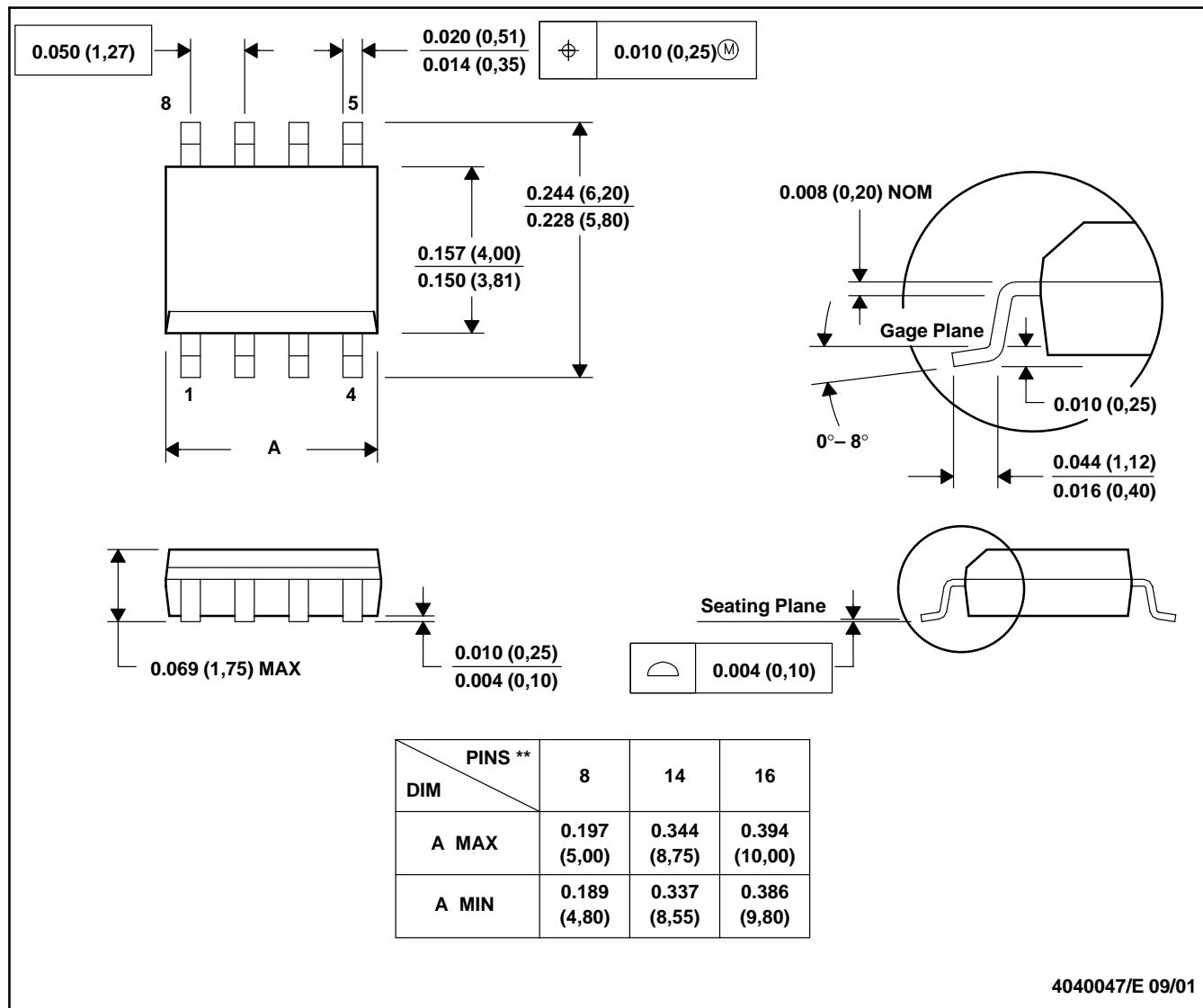
C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

## D (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



4040047/E 09/01

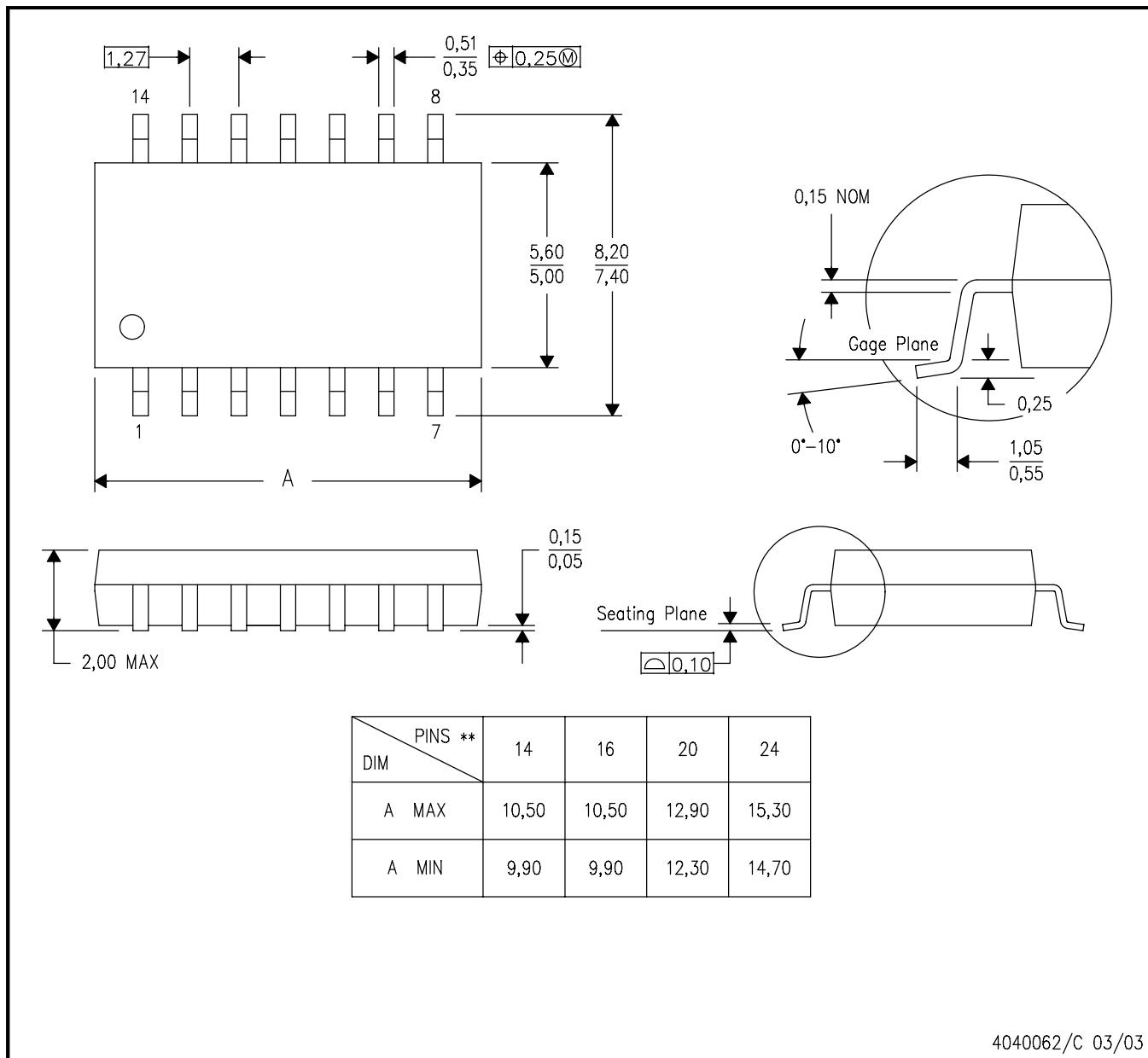
- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0.15).  
 D. Falls within JEDEC MS-012

## MECHANICAL DATA

**NS (R-PDSO-G\*\*)**

**14-PINS SHOWN**

**PLASTIC SMALL-OUTLINE PACKAGE**

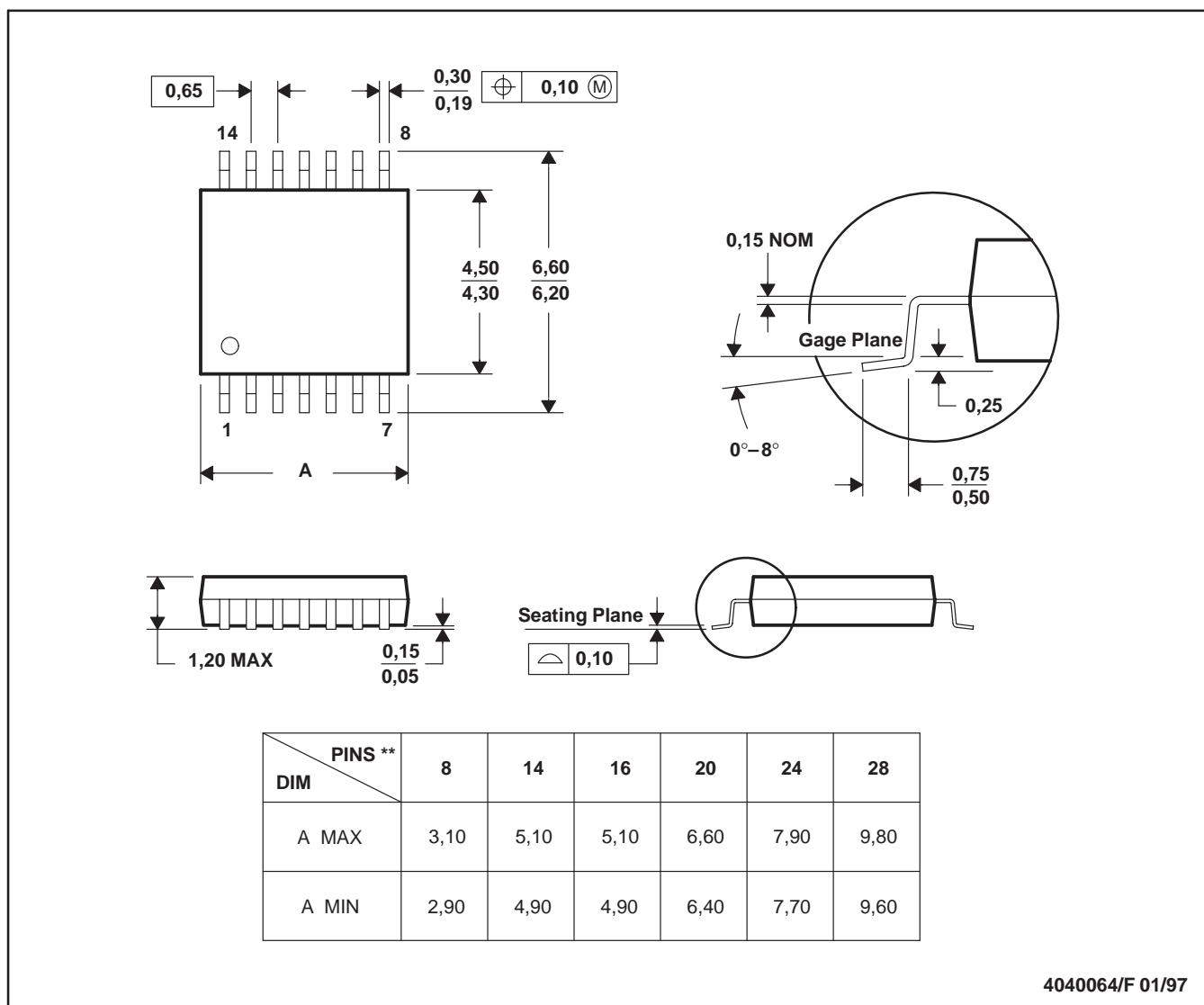


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
  - Falls within JEDEC MO-153

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